TECHNICAL DATA SHEET

FLUXEL CA 402

Date of Review : 04/11/2014 JPF IR : 2

. PRODUCT DESCRIPTION

resinous solid

. PRODUCT APPLICATION

Automatic wave tin plating or soldering iron plating of electronic cards and components in melt tinning bath maintained at a temperature of 85°C +/-5°C or as a fluxing component of cored wires.

ADVANTAGES

No need to use any complementary flux
Can be easily eliminated with common cleaning products
No need to clean the parts after brazing
No corrosive residue
Can be used on many materials as : copper, copper alloys, zinc and alloys
Halogen free

PHYSICAL PROPERTIES solid neutral organic melting point 80°C

. DIRECTIONS FOR USE

only the user can test and determine the process of use and decide if the test results are appropriate to his own or to his customer's requirements

